SLAS332 - APRIL 2001

LOW POWER AND LOW VOLTAGE 16-BIT, SINGLE-ENDED ANALOG INPUT/OUTPUT STEREO AUDIO CODEC

FEATURES

- 16-Bit Delta-Sigma ADC and DAC
- Stereo ADC:
 - Single-Ended Voltage Input
 - Anti-Aliasing Filter Included
 - High PerformanceTHD+N: -84 dBSNR: 88 dB
 - Dynamic Range: 88 dB
 1/64× Decimation Digital Filter
 Passband Ripple: ±0.05 dB
 Stopband Attenuation: -65 dB
 - Digital HPF Included
- Stereo DAC:
 - Single-Ended Voltage Output
 - Analog LPF and FIR Filter Included
 - High PerformanceTHD+N: -88 dBSNR: 92 dB
 - Dynamic Range: 92 dB
 8× Oversampling Digital Filter
 Passband Ripple: ±0.1 dB
 Stopband Attenuation: -43 dB
- Audio Data Format:
 - ADC: 16-bit, Left-JustifiedDAC: 16-bit, Right-Justified
- Special Built-In Functions:
 - Digital De-Emphasis: 32, 44.1, 48 kHz
 - ADC/DAC Independent Power Down With Pop-Noise Free Muting
- Sampling Rate: 8 kHz to 48 kHz
- System Clock: 256f_S, 384f_S, 512f_S
- Low Voltage Power Supply:
 - 2.4 V TYP, 2.1 V MIN to 3.6 V MAX
- Low Power Dissipation:
 32 mW at V_{CC} = 2.4 V
- Package: 16-Pin TSSOP

APPLICATIONS

- Digital Video Camera
- Portable MD Player
- Other Portable System

DESCRIPTION

The PCM3008 is a low cost single chip 16-bit stereo audio codec with single-ended analog voltage input and output.

Both ADCs and DACs employ delta-sigma modulation with 64-times oversampling. ADCs include a digital decimation filter and digital high pass filter. DACs include an 8-times oversampling digital interpolation filter, digital de-emphasis filter and pop-noise free muting which works during the power down ON/OFF sequence. The PCM3008 accepts left-justified format for ADC, and right-justified format for DAC. Independent power-down modes for ADC and DAC are provided.

The PCM3008 is suitable for a wide variety of cost-sensitive consumer applications where good performance is required. It is fabricated using a highly advanced CMOS process and is available in a small 16-pin TSSOP package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



PCM3008 **PACKAGE** (TOP VIEW) V_{COM} U 16 15 □ V_{OUT}L V_{IN}L \Box 3 14 D PDDA GND □ 13 □ PDAD v_{cc} □ 12 ⊐ вск DEMO \Box 11 ☐ SYSCK DEM1 □□ 10 □ LRCK DOUT I 9 □ DIN

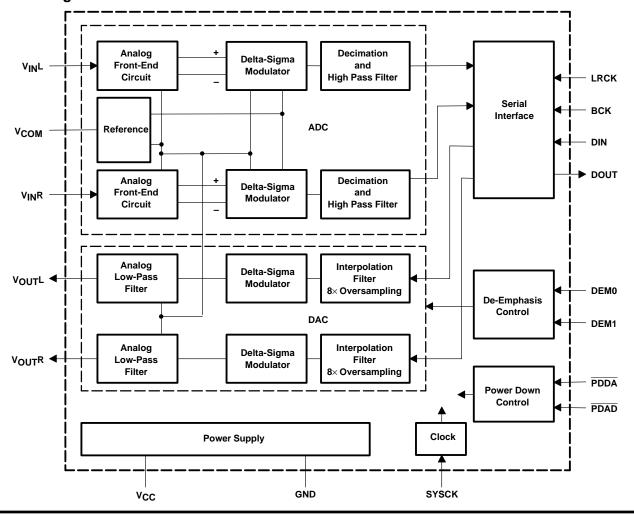
PACKAGE/ORDERING INFORMATION

| | PRODUCT PACKAGE | PACKAGE | DRAWING NUMBER | OPERATION TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER(1) | TRANSPORT MEDIA |
|---|--------------------|----------|--------------------|--------------------------------|--------------------|-----------------------|--------------------|
| ſ | DOMAGGGT | T000D 40 | 77000† | 05.00 (| DOMOGOOT | PCM3008T | Rails |
| | PCM3008T | TSSOP-16 | ZZ363 ^T | –25 °C to +85 °C | PCM3008T | PCM3008T/2K | Tape and Reel |

[†] TI equivalent no. 4040064.

NOTE: Models with a slash (/) are available only in tape and reel in the quantities indicated (e.g., /2K indicates 2000 devices per reel). Ordering 2000 pieces of PCM3008T/2K will get a single 2000-piece tape and reel.

block diagram





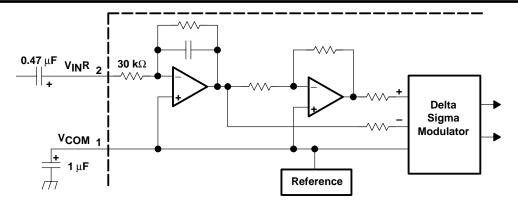


Figure 1. Analog Front-End (right-channel)

Terminal Assignments

| TERMIN | IAL | | DECODIFICAL |
|-------------------|-----|-----|---|
| NAME | NO. | I/O | DESCRIPTION |
| ∨сом | 1 | - | ADC/DAC common decouple (see Note 1) |
| V _{IN} R | 2 | I | ADC analog input, R-channel. |
| VINL | 3 | I | ADC analog input, L-channel. |
| GND | 4 | - | Ground. |
| VCC | 5 | - | Power supply. |
| DEM0 | 6 | I | De-emphasis control 0 (see Note 2) |
| DEM1 | 7 | Ι | De-emphasis control 1 (see Note 2) |
| DOUT | 8 | 0 | Data output |
| DIN | 9 | I | Data input (see Note 2) |
| LRCK | 10 | I | Sampling clock input (see Note 2) |
| SYSCK | 11 | ı | System clock input (see Note 2) |
| BCK | 12 | I | Bit clock input (see Note 2) |
| PDAD | 13 | ı | ADC power down, active low (see Note 2) |
| PDDA | 14 | I | DAC power down, active low (see Note 2) |
| VouTL | 15 | 0 | DAC analog output, L-channel. |
| VoutR | 16 | 0 | DAC analog output, R-channel. |

NOTES: 1. Connect decouple capacitor to GND.

2. Schmitt trigger input, open state can not be allowed because of no internal pullup or pulldown.



SLAS332 - APRIL 2001

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| Supply voltage, V _{CC} | 4 V |
|--|---------------------------------|
| Digital input voltage: DEM0, DEM1, DIN, LRCK, SYSCK, BCK, PDAL, PDDA | –0.3 V to 4 V |
| DOUT | 0.3 V to V _{CC} +0.3 V |
| Analog input voltage | 0.3 V to V _{CC} +0.3 V |
| Input current (any pins except supplies) | ±10 mA |
| Ambient temperature under bias | –40°C to 125°C |
| Storage temperature | –55°C to 150°C |
| Junction temperature | 150°C |
| Lead temperature (soldering) | 260°C, 5 s |
| Package temperature (IR reflow, peak) | 235°C, 10 s |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



electrical characteristics, all specifications at T_A = 25°C, V_{CC} = 2.4 V, f_S = 44.1 kHz, system clock = 384 f_S , f_{IN} = 1 kHz, 16-bit data, (unless otherwise noted)

| | DADAMETED | TEGT CONDITIONS | F | PCM3008T | | UNIT | |
|---------------------|--|----------------------------|----------------------|----------------------|----------------------|------------------|--|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
| DIGITA | AL INPUT/OUTPUT | | | | | | |
| VIH(3) | | | 0.7 V _{CC} | | 3.6 | \/D0 | |
| V _{IL} (3) | Input logic level | | | | 0.3VCC | VDC | |
| I _{IN} (3) | Input logic current | | | | ±10 | μΑ | |
| VOH ⁽⁴ | | $I_{O} = -400 \mu\text{A}$ | V _{CC} -0.2 | | | VDC | |
| V _{OL} (4 |) Output logic level | $I_{O} = 400 \mu\text{A}$ | | | 0.2 | VDC | |
| CLOC | K FREQUENCY | | | | | | |
| | Sampling frequency | | 8 | 44.1 | 48 | kHz | |
| | | 256 f _S | 2.0480 | 11.2896 | 12.2880 | | |
| f _S | System clock frequency | 384 f _S | 3.0720 | 16.9344 | 18.4320 | MHz | |
| | | 512 f _S | 4.0960 | 22.5792 | 24.5760 | | |
| ADC (| CHARACTERISTICS | • | | | | | |
| | Resolution | | | 16 | | Bits | |
| DC AC | CCURACY | | | | | | |
| | Gain mismatch channel to channel | | | ±1 | ±5 | | |
| | Gain error | | | ±2 | ±10 | % of FSR | |
| | Bipolar zero error | | | ±0 | | 1 011 | |
| DYNA | MIC PERFORMANCE ⁽⁵⁾ | • | | | | | |
| | TUDAN | $V_{IN} = -0.5 \text{ dB}$ | | -84 | -74 | | |
| | THD+N | $V_{IN} = -60 \text{ dB}$ | | -26 | | | |
| | Dynamic range | A-weighted | 82 | 88 | | dB | |
| | S/N ratio | A-weighted | 82 | 88 | | | |
| | Channel separation | | 80 | 86 | | | |
| ANAL | OG INPUT | | | | | | |
| | Input voltage | | | 0.6 V _{CC} | | V _{p-p} | |
| | Center voltage | | | 0.5 V _C C | | V | |
| | Input impedance | | | 30 | | kΩ | |
| | | −3 dB | | 150 | | kHz | |
| | Antialiasing filter frequency response | f _{IN} = 20 kHz | | -0.08 | | dB | |
| DIGITA | AL FILTER PERFORMANCE | • | • | | | | |
| | Passband | | | | 0.454 f _S | | |
| | Stopband | | 0.583 f _S | | | Hz | |
| | Passband ripple | | | | ±0.05 | | |
| | Stopband attenuation | | -65 | | | dB | |
| | Delay time | | | 17.4 f _S | | S | |
| | HPF frequency response | -3 dB | | 0.078 f _S | | mHz | |
| DAC | CHARACTERISTICS | l | ı | - 3 | | | |
| <u> </u> | Resolution | | | 16 | | Bits | |

NOTES: 3. Pins 6, 7, 9, 10–14: DEM0, DEMI, DIN, LRCK, SYSCK, BCK, PDAD, PDDA, (Schmitt trigger input, 3.3 V tolerant.



^{4.} Pin 8: DOUT

^{5.} f_{IN} = 1 kHz, using audio precision system II, RMS mode with 20 kHz LPF, 400 Hz HPF in calculation.

electrical characteristics, all specifications at T_A = 25°C, V_{CC} = 2.4 V, f_S = 44.1 kHz, system clock = 384 f_S , f_{IN} = 1 kHz, 16-bit data, (unless otherwise noted) (continued)

| | | | | Р | CM3008T | | |
|-------------|----------------------------------|----------------------------|-------------------------|----------------------|----------------------|----------------------|------------------|
| | PARAMETER | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
| DC AC | CURACY | | | | | | |
| | Gain mismatch channel to channel | | | | ±1 | ±5 | |
| | Gain error | | | | ±2 | ±10 | %of FSR |
| | Bipolar zero error | | | | ±2 | | |
| DYNAM | MIC PERFORMANCE ⁽⁶⁾ | | | | | | |
| | TUDAN | V _{OUT} = 0 dB | | | -88 | -78 | |
| | THD+N | $V_{OUT} = -60 \text{ dB}$ | | | -30 | | |
| | Dynamic range | EIAJ, A-weighted | | 86 | 92 | | dB |
| | S/N ratio | EIAJ, A-weighted | | 86 | 92 | | |
| | Channel separation | | | 84 | 90 | | |
| ANALC | OG OUTPUT | | | | | | |
| | Output voltage | | | | 0.6 V _C C | | V _{p-p} |
| | Center voltage | | | | 0.5 V _C C | | V |
| | Load impedance | AC coupling | | 10 | | | kΩ |
| | | -3 dB | | | 250 | | kHz |
| | LPF frequency response | f _{IN} = 20 kHz | | | -0.03 | | dB |
| DIGITA | L FILTER PERFORMANCE | • | | • | | | |
| | Passband | | | | | 0.445 f _S | 1.1- |
| | Stopband | | | 0.555 f _S | | | Hz |
| | Passband ripple | | | | | ±0.1 | |
| | Stopband attenuation | | | -43 | | | dB |
| | Delay time | | | | 14.3 f _S | | s |
| POWER | R SUPPLY REQUIREMENTS | • | | | | | |
| Vcc | Voltage range | | | 2.1 | 2.4 | 3.6 | VDC |
| | | ADC, DAC operation, | | | 13.2 | 17 | |
| | | ADC operation |],, | | 8.1 | 10.5 | mA |
| | Supply current | DAC operation | V _{CC} = 2.4 V | | 5.6 | 7.5 | |
| | | ADC, DAC power down(7) |] | | 20 | 50 | μΑ |
| | | ADC, DAC operation, | | | 31.7 | 40.8 | mW |
| | | ADC operation |],, | | 19.4 | 25.2 | |
| | Power dissipation | DAC operation | V _{CC} = 2.4 V | | 13.4 | 18 | |
| | | ADC, DAC power down(7) | 1 | | 48 | 120 | μW |
| TEMPE | RATURE RANGE | | | - | | | • |
| | | | f _S > 24 kHz | -25 | | 85 | |
| | Operation temperature | VCC = VMIN to $VMAX$ | f _S < 24 kHz | -25 | | 70 | °C |
| θ JA | Thermal resistance | 16-pin TSSOP | | | 150 | | °C/W |

^{6.} f_{IN} = 1 kHz, using audio precision system II, RMS mode with 20 kHz LPF, 400 Hz HPF. 7. SYSCK, BCK, LRCK are stopped.



theory of operation

ADC section

The PCM3008 ADC consists of a reference circuit, a stereo single-to-differential converter, a stereo fully differential 5th-order delta-sigma modulator, a digital decimation filter with high pass filter function and a serial interface circuit. The block diagram in this data sheet illustrates the architecture of the ADC section and Figure 1 shows the single-to-differential converter.

An internal reference circuit with one external capacitor provides all reference voltages required by the ADC and DAC. The internal single-to-differential voltage converter saves the design, space and extra parts needed for external circuitry required by many delta-sigma converters. The internal full-differential signal processing architecture provides a wide dynamic range and excellent power supply rejection performance. The input signal is sampled at 64× oversampling rate, eliminating the need for a sample-and-hold circuit, and simplifying anti-alias filtering requirements. The 5th-order delta-sigma noise shaper consists of five integrators that use a switched-capacitor topology, a comparator and a feedback loop consisting of a one-bit DAC. The delta-sigma modulator shapes the quantization noise, shifting it out of the audio band in the frequency domain.

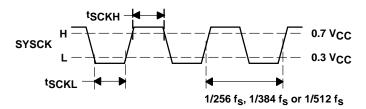
The $64f_S$ one-bit data stream from the modulator is converted to $1f_S$ 16-bit data words by the decimation filter, which also acts as a low pass filter to remove the shaped quantization noise. The dc components are removed by a high pass filter function contained within the decimation filter.

DAC section

The PCM3008 DAC consists of a serial interface circuit, a $8\times$ digital interpolation filter with de-emphasis filter function, a stereo 5th-order delta-sigma modulator, and a stereo analog FIR filter with LPF and output buffer amplifier. The block diagram in this data sheet illustrates the architecture of the DAC section. $1f_s$ 16-bit audio data is converted to $8f_s$ 18-bit data by an $8\times$ oversampling interpolation filter, and then converted to $64f_s$ one-bit data by delta-sigma modulator. One-bit digital data is converted to an analog signal by a current source D to A, and then high frequency components of the shaped quantization noise out of band is reduced by the analog FIR filter and LPF. The fade in, fade out function in digital domain, and V_{OUT} control circuit in analog domain provide a pop-noise free muting function that is required for the power down on/off control sequence.

system clock

The system clock for PCM3008 must be either $256f_s$, $384f_s$ or $512f_s$, where f_s is the audio sampling frequency. The system clock must be supplied on SYSCK (pin 11). PCM3008 also has a system clock detection circuit that automatically senses $256f_s$, $384f_s$ or $512f_s$ mode, and when $384f_s$ or $512f_s$ system clock is used, the clock is divided into $256f_s$ automatically. The $256f_s$ clock is used to operate the digital filter and the modulator. The system clock must be supplied whenever power is applied and either \overline{PDAD} or \overline{PDDA} is HIGH, as the PCM3008 uses dynamic circuits internally. Table 1 lists the relationship of typical sampling frequency and system clock frequency, and Figure 2 illustrates the system clock timing.



| SYMBOL | DEFINITION | MIN | UNIT |
|--------|-------------------------------|-----|------|
| tSCKH | System clock pulse width HIGH | 15 | ns |
| tSCKL | System clock pulse width LOW | 15 | ns |

Figure 2. System Clock Timing



system clock (continued)

Table 1. System Clock Frequencies

| SAMPLING RATE FREQUENCY | SYSTEM CLOCK FREQUENCY (MHz) | | | | |
|-------------------------|------------------------------|-------------------|-------------------|--|--|
| (kHz) | 256f _S | 384f _S | 512f _S | | |
| 32.0 | 8.1920 | 12.2880 | 16.3840 | | |
| 44.1 | 11.2896 | 16.9340 | 22.5792 | | |
| 48.0 | 12.2880 | 18.4320 | 24.5760 | | |

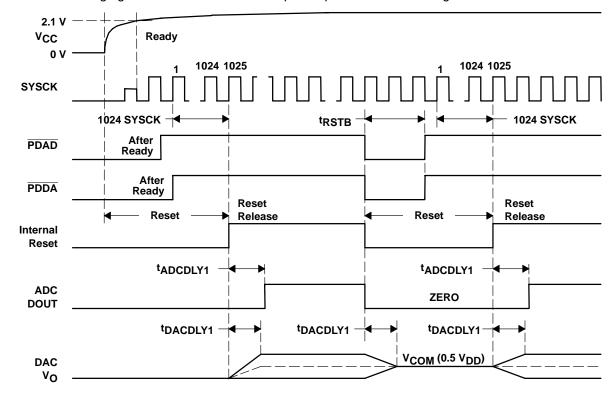
reset

The ADC and DAC portions of the PCM3008 can be reset simultaneously by the power down control pins, \overline{PDAD} and \overline{PDDA} . This external reset using \overline{PDAD} and \overline{PDDA} must be always done at least once after the power is applied. Internal state is kept in reset during \overline{PDAD} = low and \overline{PDDA} = low and for 1024 system clock counts after \overline{PDAD} = high or \overline{PDDA} = high, and then the initialization sequence for ADC and DAC is started. For the ADC, DOUT is kept in ZERO during the initialization sequence and DOUT outputs normal data corresponding to the input analog signal after $t_{ADCDLY1}$. In the case of the DAC, the fade-in function is started, the signal level on $t_{ADCDLY1}$ increases gradually and reaches to full level corresponding to the input digital signal after $t_{ADCDLY1}$. The following figure illustrates the reset timing for power-on and the ADC/DAC output response for the power-on and reset sequence.



PCM audio interface

Digital audio data is interfaced to the PCM3008 on LRCK (pin 10), BCK (pin 12), DIN (pin 9), and DOUT (pin 8). PCM3008 can accept 16-bit standard format, right-justified 16 bit for DAC and left-justified 16 bit for ADC. PCM3008 accepts 3 types of BCK and LRCK combination, with 64, 48 or 32 clocks of BCK in one clock of LRCK. The following figures illustrate audio data input/output format and timing.



| SYMBOL | DEFINITION | MIN | TYP | MAX | UNIT |
|----------------------|--|-----|---------------------|-----|------|
| ^t RSTB | PDAD = LOW and PDDA = LOW pulse width | 40 | | | ns |
| ^t ADCDLY1 | Initial delay time 2240/f _S | | | S | |
| ^t DACDLY1 | Fade in, fade out time | | 2080/f _S | | S |

Figure 3. Power-On Reset Timing

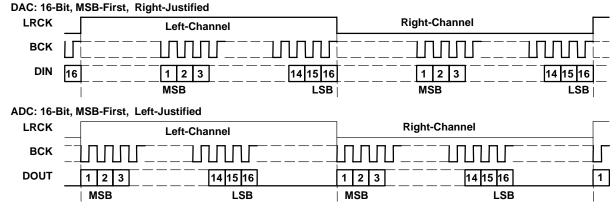
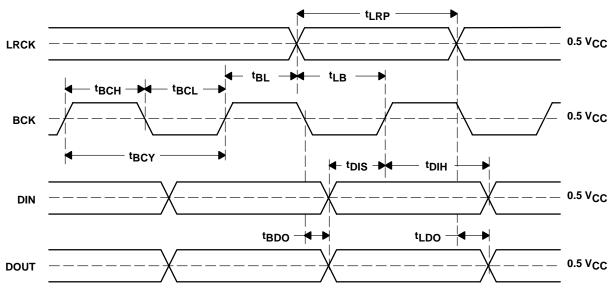


Figure 4. Audio Data Input/Output Format



PCM audio interface (continued)



| SYMBOL | DEFINITION | MIN | TYP | MAX | UNITS |
|------------------|-------------------------------------|------|-----|-----|-------|
| tBCY | BCK pulse cycle time | 300 | | | ns |
| ^t BCH | BCK pulse width high | 120 | | | ns |
| tBCL | BCK pulse width low | 120 | | | ns |
| t _{BL} | BCK rising edge to LRCK edge | 40 | | | ns |
| t _{LB} | LRCK edge to BCK rising edge | 40 | | | ns |
| tLRP | LRCK pulse width | tBCY | | | |
| tDIS | DIN setup time | 40 | | | ns |
| ^t DIH | DIN hold time | 40 | | | ns |
| tBDO | DOUT delay time to BCK falling edge | | | 40 | ns |
| tLDO | DOUT delay time to LRCK edge | | | 40 | ns |
| t _R | Rising time of all signals | | | 20 | ns |
| tF | Falling time of all signals | | | 20 | ns |

Figure 5. Audio Data Input/Output Timing

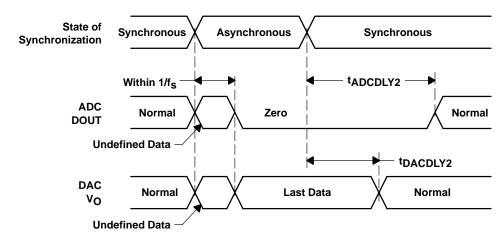
synchronization with digital audio system

PCM3008 operates with LRCK synchronized to the system clock. PCM3008 does not need a specific phase relationship between LRCK and system clock, but does require the synchronization of LRCK and system clock. If the relationship between system clock and LRCK changes more than ± 4 BCK during one sample period, internal operation of DAC halts within $1/f_s$, and analog output is held at the last data until re-synchronization between system clock and LRCK is completed, and $t_{DACDLY2}$ has elapsed.

Internal operation of ADC also halts within $1/f_s$, and digital output is forced into ZERO code until re-synchronization between system clock and LRCK is completed and $t_{ADCDLY2}$ has elapsed. In case of changes less than ± 4 BCK, re-synchronization does not occur and the above analog/digital output control and discontinuity do not occur. The following figure illustrates the DAC analog output and ADC digital output for loss of synchronization. During undefined data periods, some noise may be generated in the audio signal. Also, the transition of normal to undefined data and undefined data to normal makes a discontinuity of data on analog and digital output, which also may generate some noise in the audio signal.

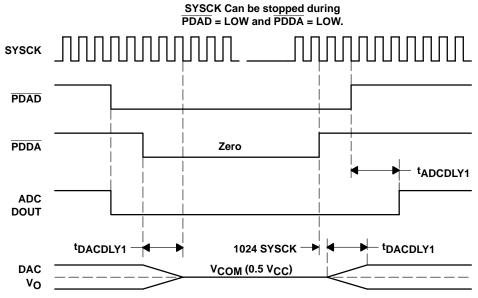


synchronization with digital audio system (continued)



| SYMBOL | DEFINITION | MIN | TYP | MAX | UNIT |
|----------------------|---------------------------------|-----|-------------------|-----|------|
| tADCDLY2 | Delay time from synchronization | | 32/f _S | | s |
| ^t DACDLY2 | Delay time from synchronization | | 32/f _S | | S |

Figure 6. ADC and DAC Output for Loss of Synchronization



| SYMBOL | DEFINITION | MIN | TYP | MAX | UNIT |
|----------------------|------------------------|-----|---------------------|-----|------|
| ^t ADCDLY1 | Initial delay time | | 2240/f _S | | s |
| ^t DACDLY1 | Fade in, fade out time | | 2080/f _S | | S |

Figure 7. ADC and DAC Output for Power Down Control

function control

The PCM3008 has the following functions which are controlled by PDAD (pin 13), PDDA (pin 14), DEM0 (pin 6) and DEM1 (pin 7).

power-down control

PDAD: ADC power-down control pin places the ADC portion in the lowest power consumption mode. The ADC operation is stopped by disabling the clock and bias to the ADC portion, and DOUT is forced to zero during ADC power-down mode. Figure 7 illustrates the ADC DOUT response for ADC power-down ON/OFF. This does not affect the DAC operation.

| PDAD | ADC OPERATION MODE |
|------|-----------------------------|
| Low | ADC power down mode enable |
| High | ADC power down mode disable |

| PDDA | DAC OPERATION MODE | | | | |
|------|-----------------------------|--|--|--|--|
| Low | DAC power down mode enable | | | | |
| High | DAC power down mode disable | | | | |

 \overline{PDAD} = low and \overline{PDDA} = low places PCM3008 into reset state and either \overline{PDAD} = high or \overline{PDDA} = high returns PCM3008 to operational state.

de-emphasis control

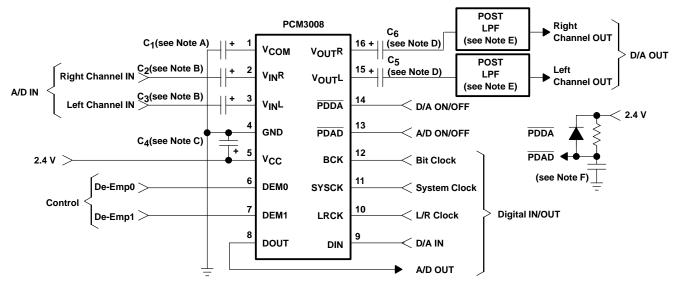
DEM1, **DEM0**: DAC de-emphasis control pins select the de-emphasis mode as shown below.

| DEM1 | DEM0 | DE-EMPHASIS MODE |
|------|------|-------------------------|
| Low | Low | De-emphasis 44.1 kHz ON |
| Low | High | De-emphasis OFF |
| High | Low | De-emphasis 48 kHz ON |
| High | High | De-emphasis 32 kHz ON |



typical circuit connection

The following figure illustrates a typical PCM3008 circuit connection.



NOTES: A. C₁: 0.1 μF ceramic and 1 μF chemical typical, gives settling time with 15 ms (1 μF × 15 kΩ) time constant in power on period.

- B. C₂, C₃: 0.47 μ F typical, gives 11 Hz cutoff frequency of input HPF in normal operation and gives settling time with 14 ms (0.47 μ F × 30 k Ω) time constant in power on and power down off period.
- C. C_4 : 0.1 μF ceramic and 10 μF chemical typical, depending on power supply quality and pattern layout.
- D. C_5 , C_6 : 1 μ F typical, gives 16 Hz cut-off frequency of output HPF in normal operation and gives settling time with 10 ms (1 μ F \times 10 k Ω) time constant in power on period.
- E. Post low pass filter with $R_{IN} > 10 \text{ k}\Omega$, depending on requirement of system performance.
- F. Power on reset circuit in case of no power-down control requirement.

board design and layout considerations

power supply and grounding (V_{CC}, GND)

The analog and digital power supply lines are internally tied, and the analog and digital grounds are internally tied due to pin count limitation. The power supply V_{CC} pin must be bypassed to the GND pin with 0.1 μ F ceramic and 10 μ F chemical capacitors as close to the pins as possible to maximize the dynamic performance of ADC and DAC.

V_{IN} pins

A chemical capacitor from 0.47 μ F to 4.7 μ F is recommended as an ac coupling capacitor. Capacitance of 0.47 μ F gives 11 Hz cut-off frequency at input HPF. If higher full scale input voltage is required, it can be adjusted by adding only one series resistor to V_{IN} pins.

V_{COM} input

A 0.1 μ F ceramic and a 1 μ F or larger chemical capacitor are recommended between V_{COM} and GND to ensure low source impedance of ADC and DAC common voltage. This capacitor should be located as close as possible to the V_{COM} pin to reduce dynamic errors on the ADC and DAC common voltage.



system clock

Dynamic performance may be influenced by the quality of SYSCK. Therefore the duty cycle, jitter and threshold voltage at the SYSCK pin must be carefully managed. The SYSCK and BCK, LRCK must be supplied whenever the power is applied and either PDAD or ODDA is HIGH, as the PCM3008 uses dynamic circuits internally.

reset control

The PCM3008 does not have an internal power-on reset circuit. Therefore external reset control by PDAD and PDDA must always done at least once after the power is turned on. If neither PDAD nor PDDA is needed in the application, the standard reset circuit which consists of one resistor, one capacitor and one diode is recommended on PDAD and PDDA pins.

external mute control

Although the PCM3008 has an internal muting function for power-down ON/OFF control, if external muting control is required, the recommended control sequence is described by External Mute ON, CODEC Power Down ON, SYSCK stop and resume if necessary, CODEC Power Down OFF and External Mute OFF.



ADC



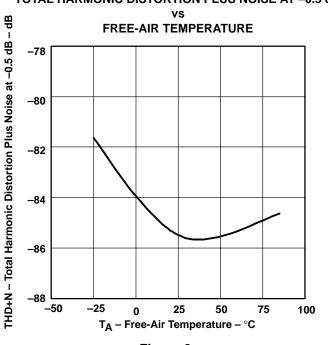
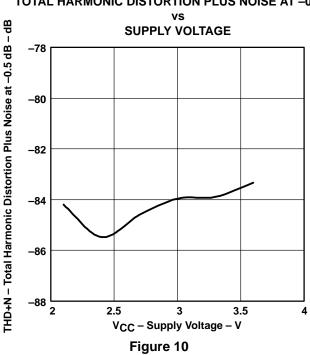


Figure 8

FREE-AIR TEMPERATURE 92 90 Dynamic Range And SNR - dB SNR 88 **Dynamic Range** 86 84 82 **-50** -25 25 50 75 100 T_A – Free-Air Temperature – °C Figure 9

DYNAMIC RANGE AND SNR

TOTAL HARMONIC DISTORTION PLUS NOISE AT -0.5 dB



DYNAMIC RANGE AND SNR vs

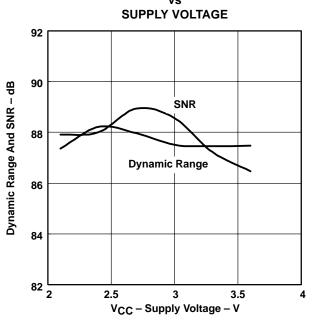
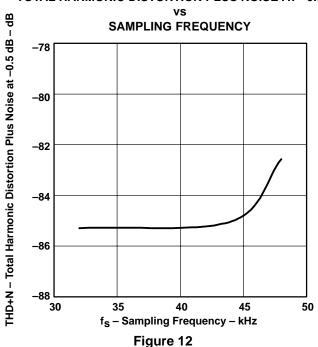


Figure 11

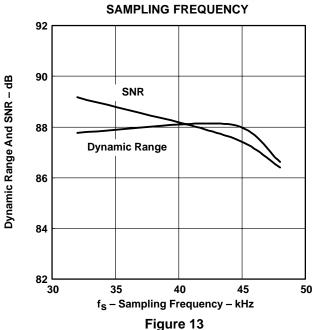


ADC



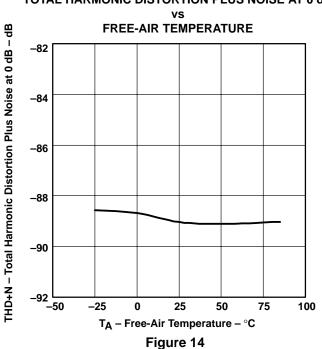


DYNAMIC RANGE AND SNR



DAC

TOTAL HARMONIC DISTORTION PLUS NOISE AT 0 dB



DYNAMIC RANGE AND SNR vs

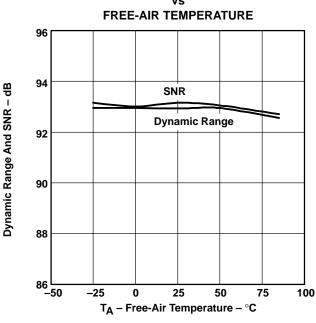


Figure 15

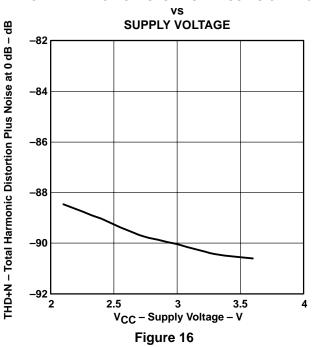


88

86<u></u>2

DAC

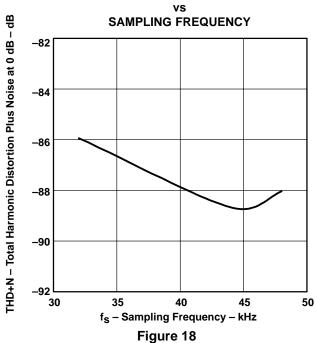
TOTAL HARMONIC DISTORTION PLUS NOISE AT 0 dB



SUPPLY VOLTAGE 96 SNR 94 Dynamic Range And SNR - dB **Dynamic Range** 92 90

DYNAMIC RANGE AND SNR ٧S

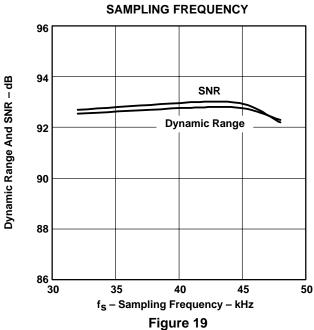
TOTAL HARMONIC DISTORTION PLUS NOISE AT 0 dB



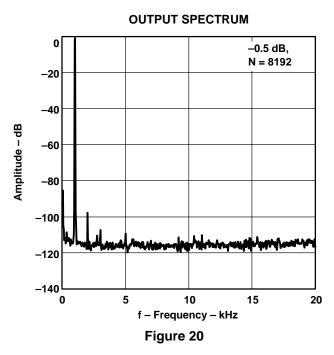
DYNAMIC RANGE AND SNR

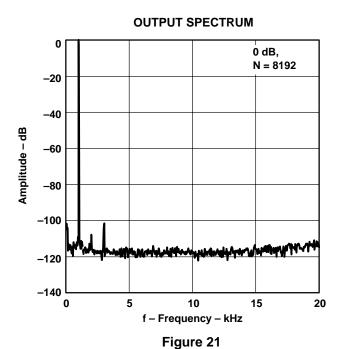
V_{CC} - Supply Voltage - V

Figure 17

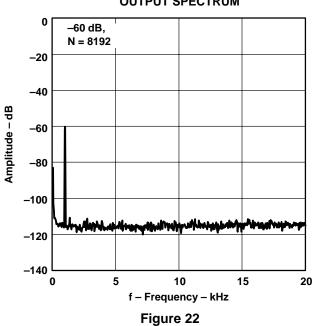


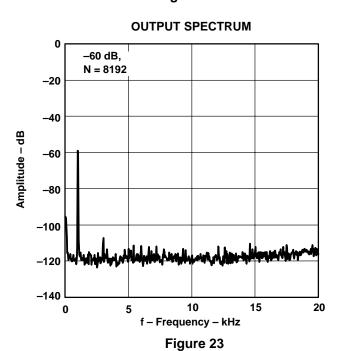
ADC DAC

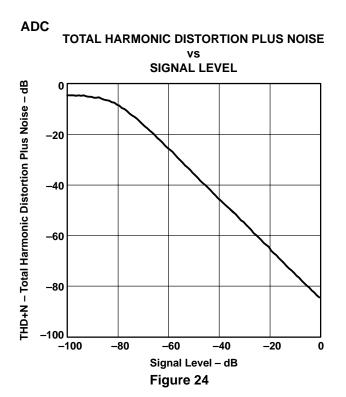


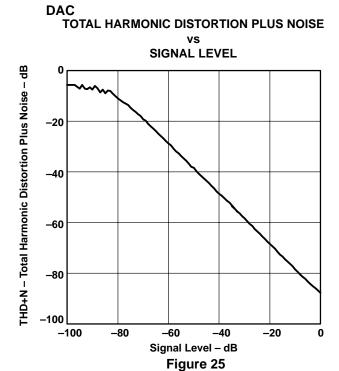


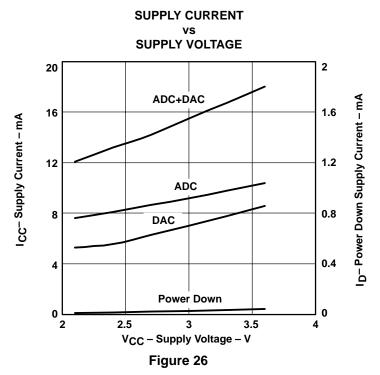
OUTPUT SPECTRUM

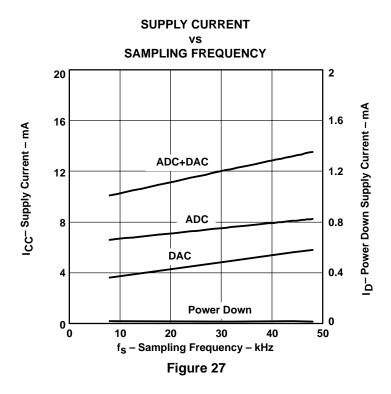




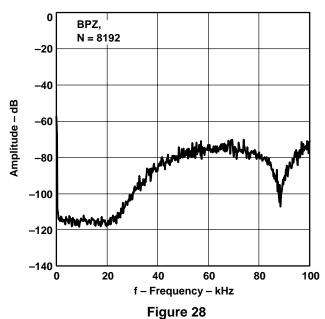




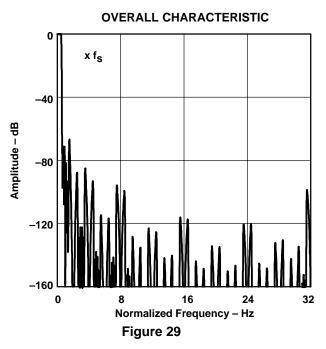


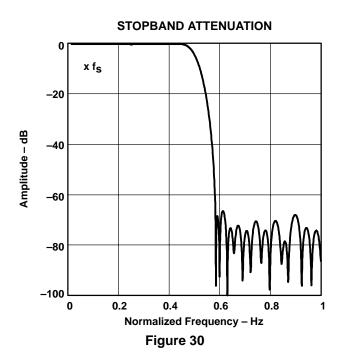


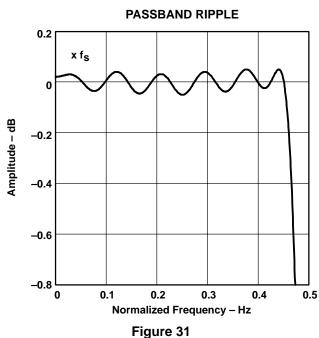
DAC OUTBAND NOISE SPECTRUM

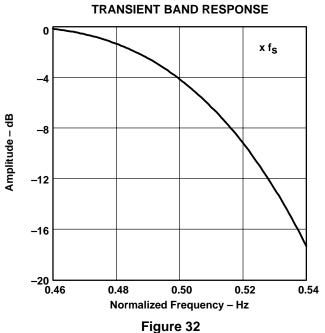


ADC digital decimation filter frequency response

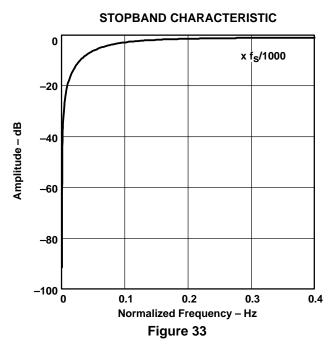


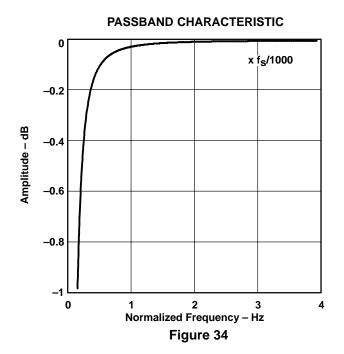




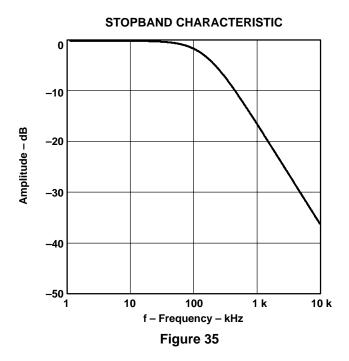


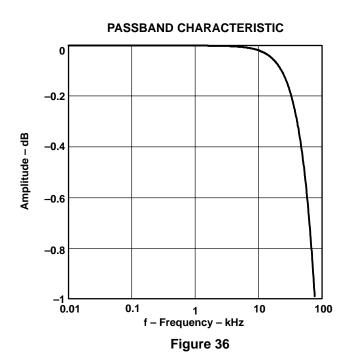
digital high pass filter frequency response



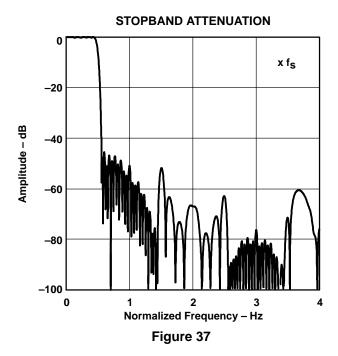


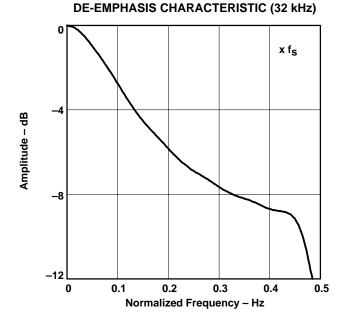
analog antialiasing filter frequency response



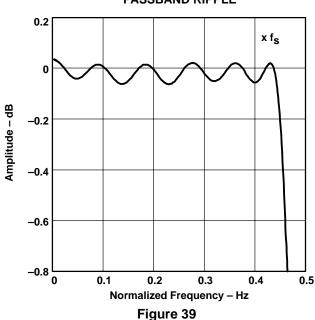


DAC digital interpolation and de-emphasis filter frequency response



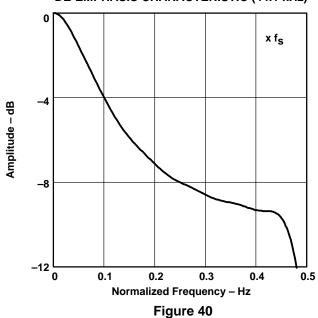




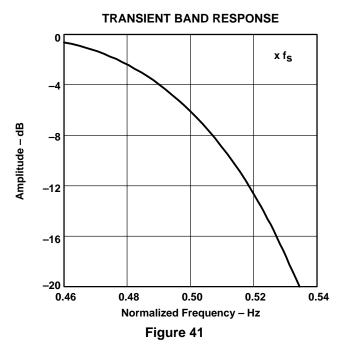


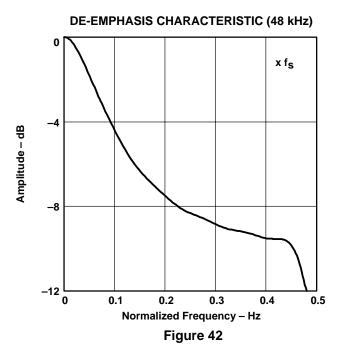
DE-EMPHASIS CHARACTERISTIC (44.1 kHz)

Figure 38

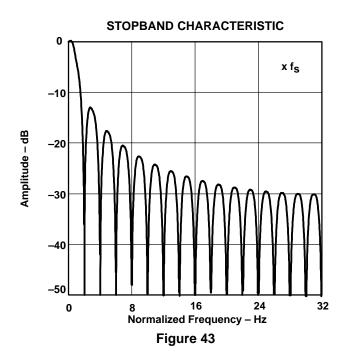


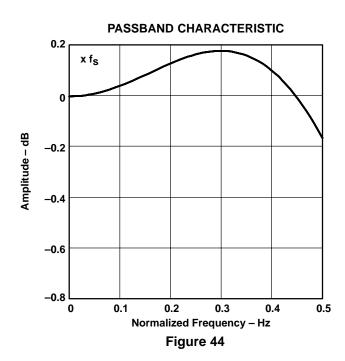
DAC digital interpolation and de-emphasis filter frequency response (continued)



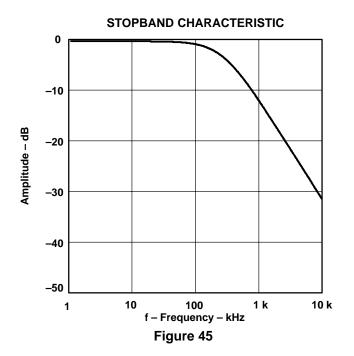


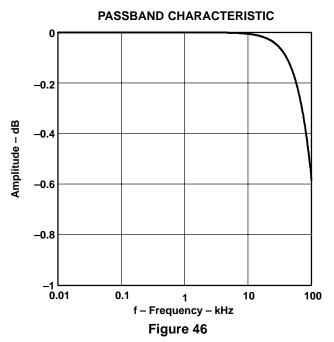
analog FIR filter frequency response

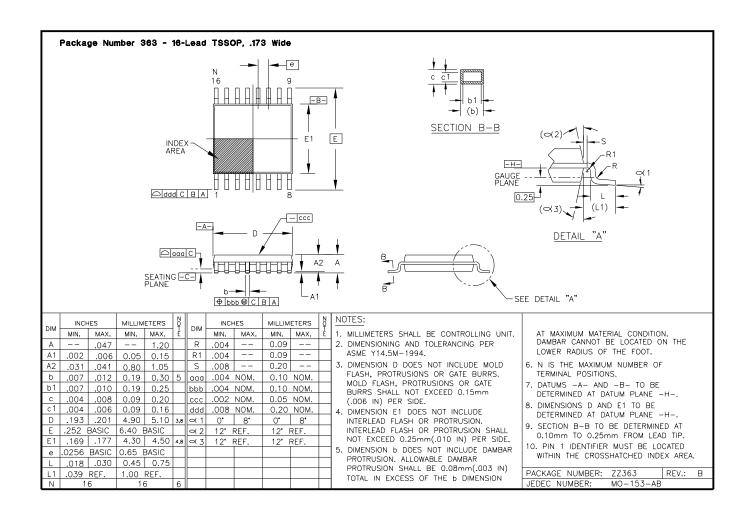




analog low pass filter frequency response











.com 12-Mar-2008

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| PCM3008T | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| PCM3008T/2K | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| PCM3008T/2KG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| PCM3008TG4 | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

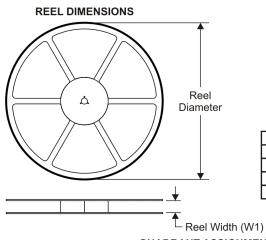
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

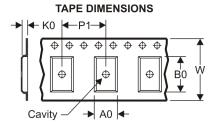
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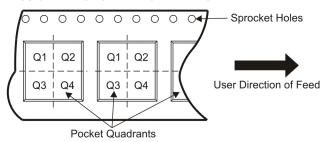
TAPE AND REEL INFORMATION





| _ | | |
|---|----|---|
| | A0 | Dimension designed to accommodate the component width |
| Γ | B0 | Dimension designed to accommodate the component length |
| | | Dimension designed to accommodate the component thickness |
| | W | Overall width of the carrier tape |
| Γ | P1 | Pitch between successive cavity centers |

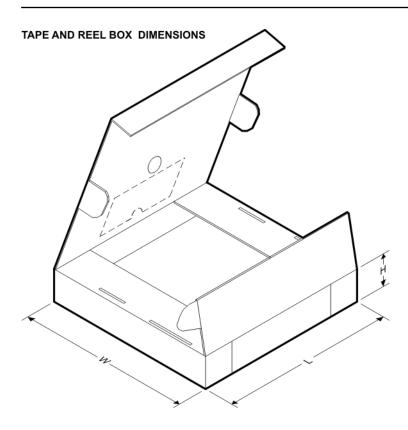
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | | Package Drawing | | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|-------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| PCM3008T/2K | TSSOP | PW | 16 | 2000 | 330.0 | 17.4 | 6.8 | 5.4 | 1.6 | 8.0 | 16.0 | Q1 |





*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| PCM3008T/2K | TSSOP | PW | 16 | 2000 | 346.0 | 346.0 | 33.0 |

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